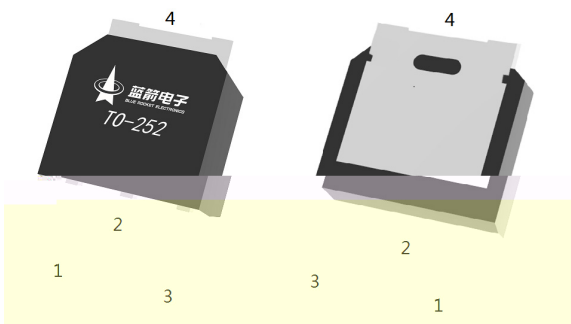
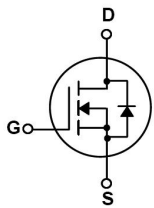


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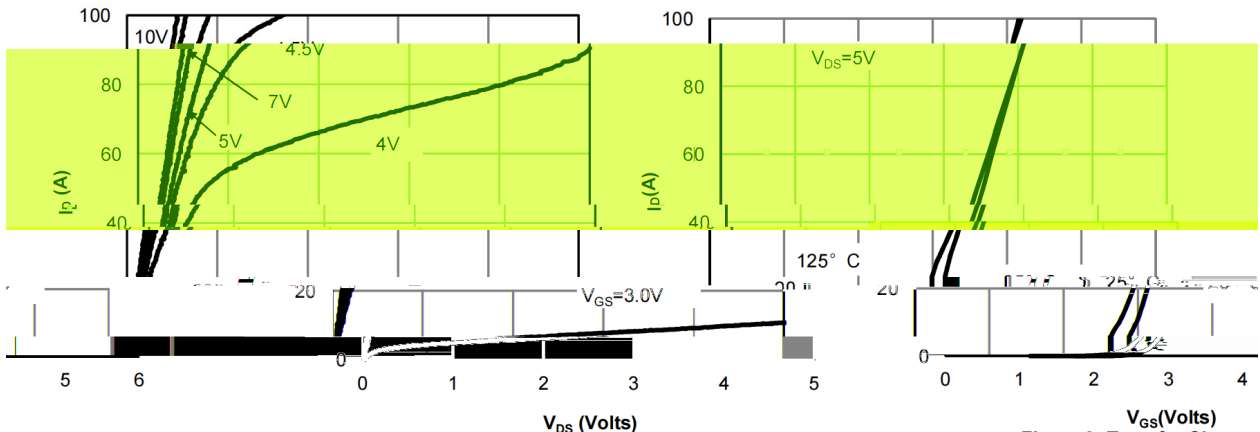


Fig 1: On-Region Characteristics

Figure 2: Transfer Characteristics

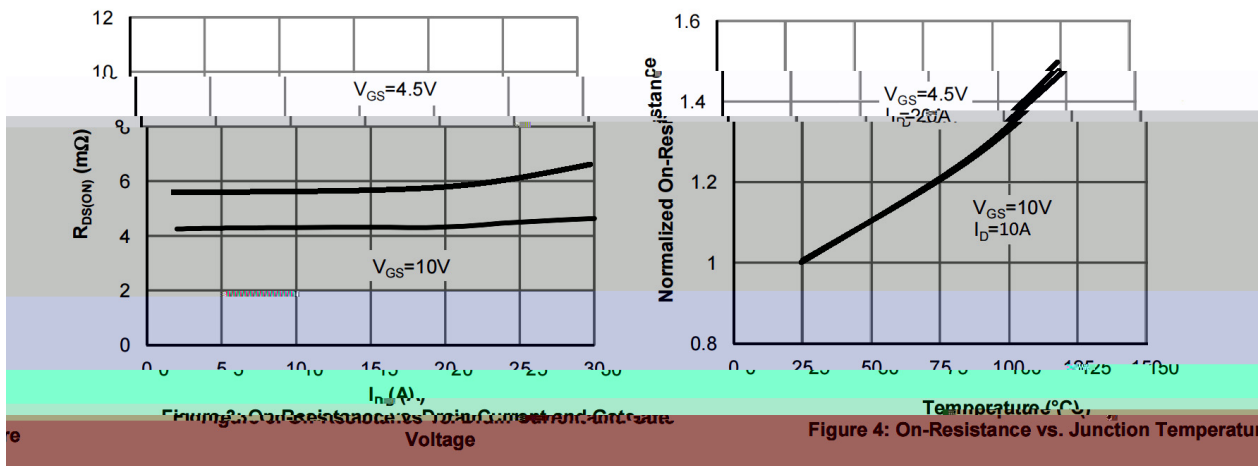


Figure 3: On-Resistance vs. Drain Current and Gate-Source Voltage

Figure 4: On-Resistance vs. Junction Temperature

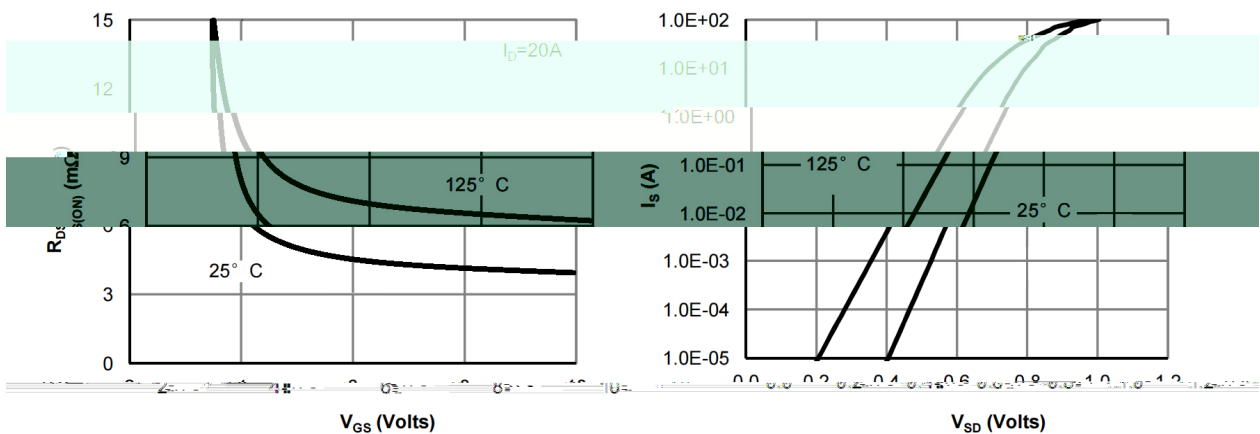


Figure 5: On-Resistance vs. Gate-Source Voltage

Figure 6: Body-Diode Characteristics

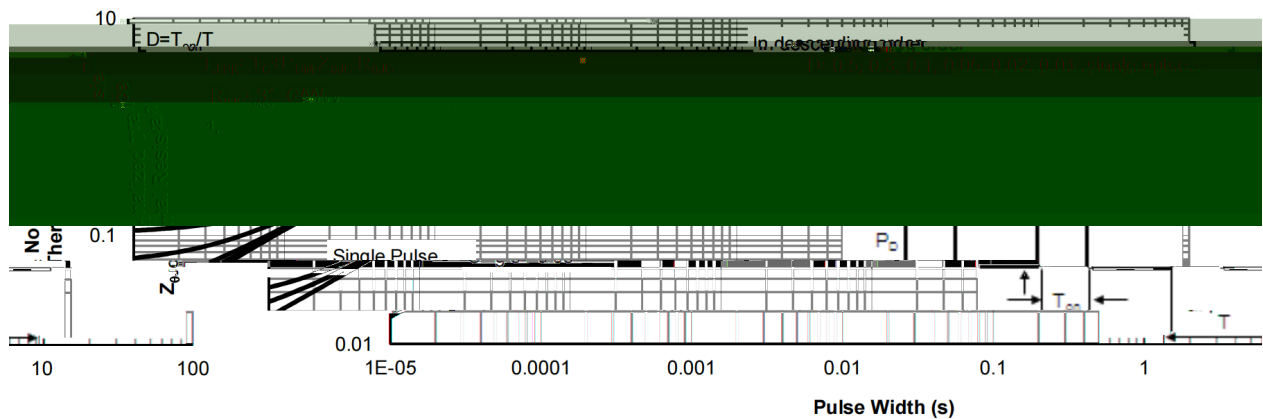
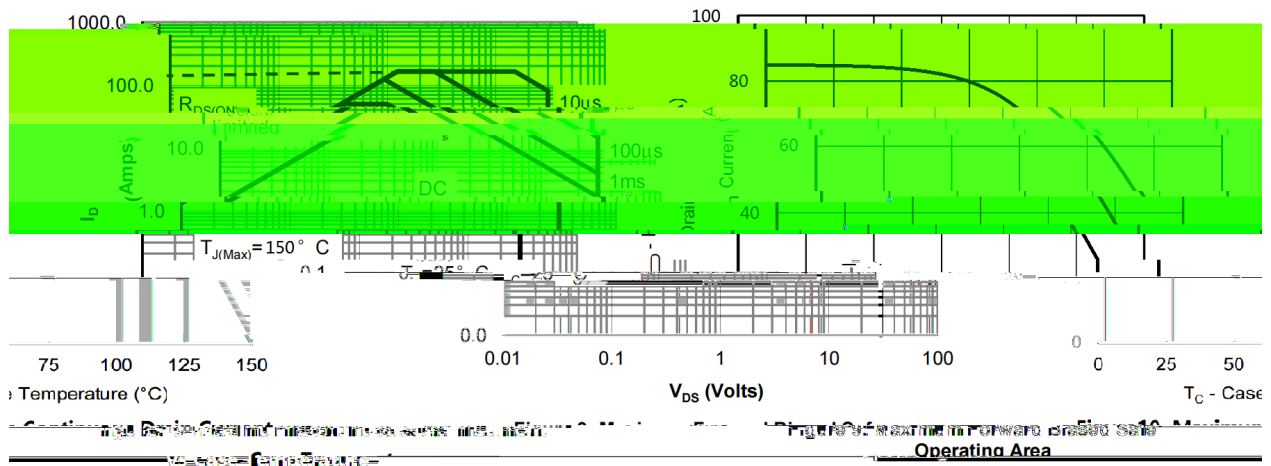
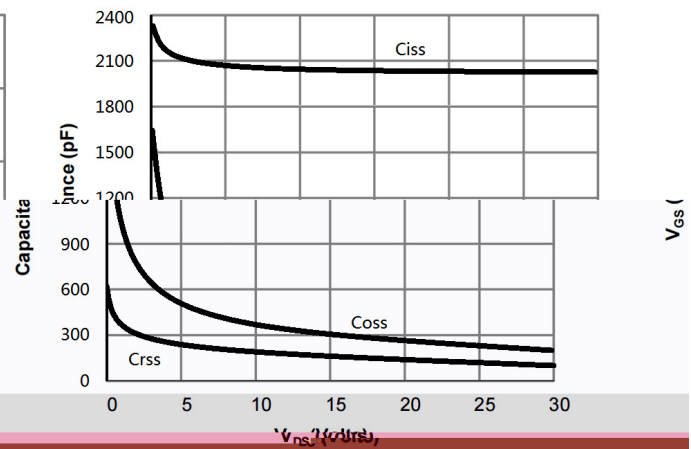
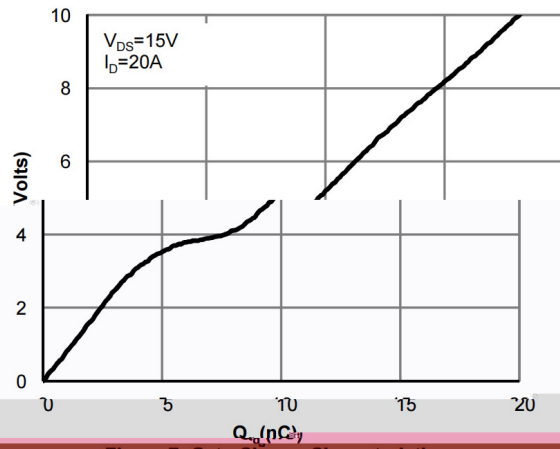
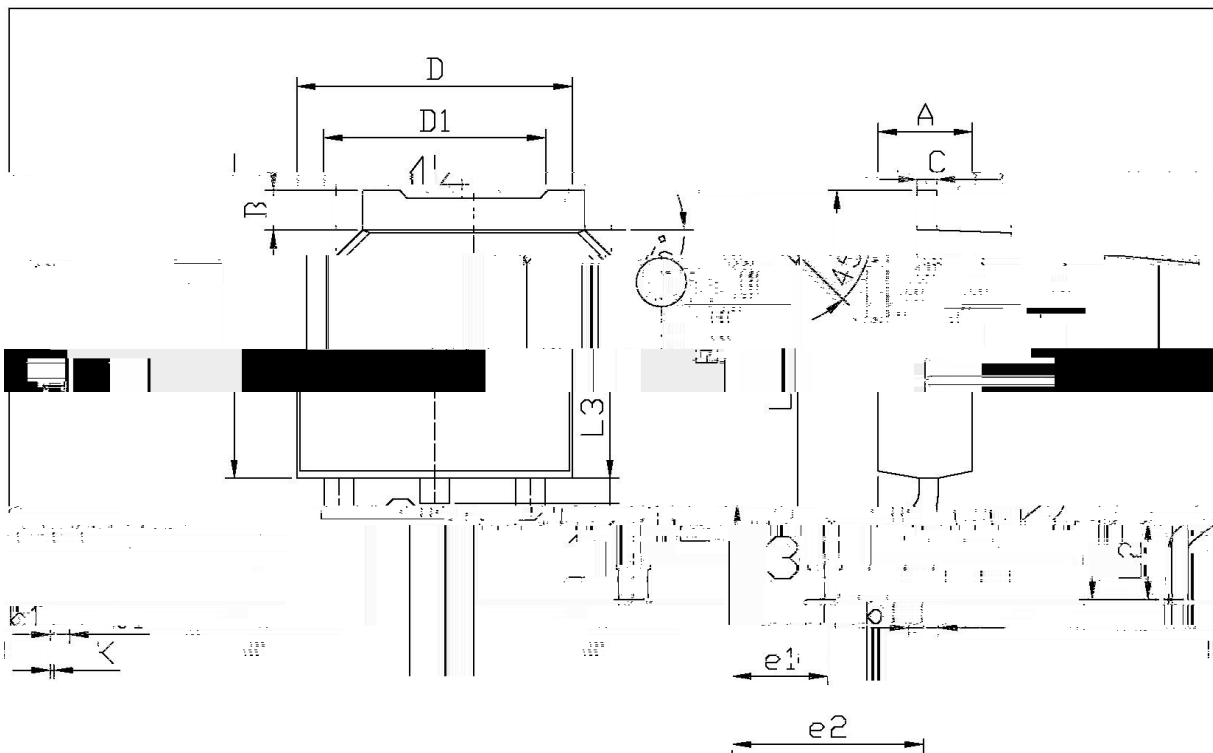


Figure 11: Normalized Maximum Transient Thermal Impedance

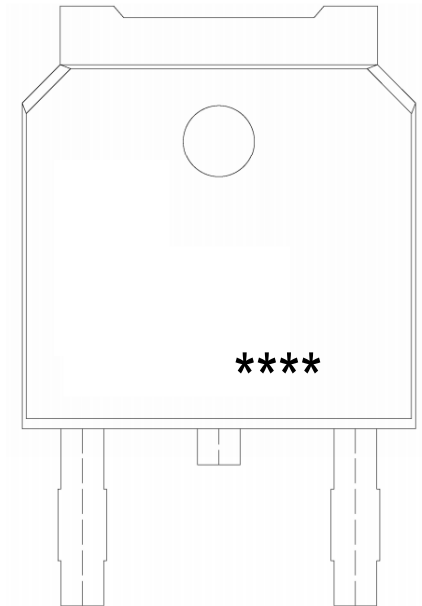
TO-252#



单位: mm

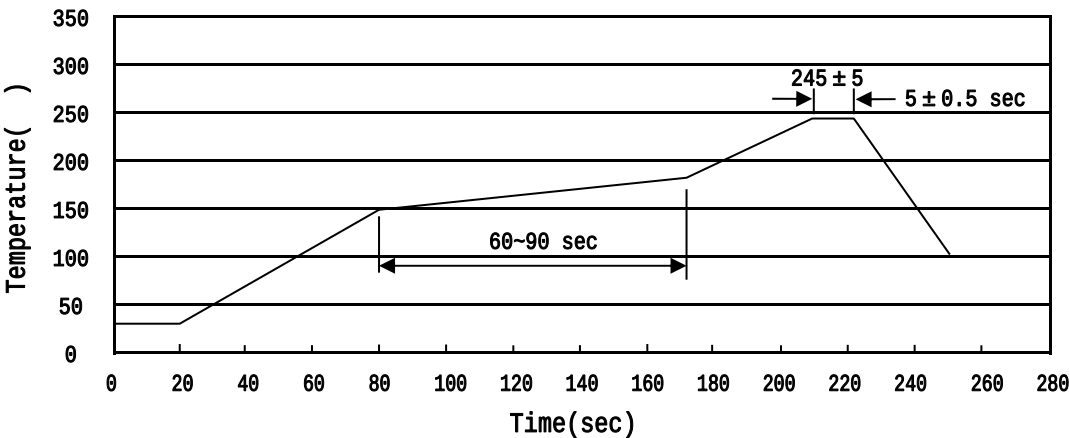
Symbol		Dimensions In Millimeters		Symbol		Dimensions In Millimeters	
		Min	Max			Min	Max
1	5.95	6.25		A	2.20	2.40	
1.25	e1	2.24	2.34	B	0.95		
2.00	3.3	4.42	4.73	b	0.70		
15	0.55	L1	9.85	10.35	b1	0.7	
	c	0.45	0.55	12	1.70	2.00	
	0.60	0.90		D	6.45	6.75	L3
	0.00	0.10		D1	5.10	5.50	K

T0-252



040N03

Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

± ±

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
TO-252	2,500	2	5,000	6	30,000	13 ×16	360×360×50	380×335×366

封装形式	包装数量					包装尺寸		
	Units/Tube 只/套管	Tubes/Inner Box 套管/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Tube 套管	Inner Box 盒	Outer Box 箱
TO-251/252	75	48	3,600	5	18,000	526×20.5×5.25	555×164×50	575×290×180